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APPLICATION NUMBER	FILING DATE	CRR ARTINET		_			www.uspia.gov
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FILING RECEIPT

Date Mailed: 10/17/2000

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Applicant(s)

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Continuing Data as Claimed by Applicant

Foreign Applications

JAPAN 11-246582 08/31/1999 JAPAN 2000-252881 08/23/2000

If Required, Foreign Filing License Granted 10/17/2000

Title

Semiconductor substrate and its fabrication method

Preliminary Class

257

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